PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Isao OCHIAI Group Art Unit: 1722

Serial No. 10/772,345 Examiner: Robert B. Davis

Filed: February 6, 2004 Attorney Docket No. 2905-107

Confirmation No.: 5051

For: LEAD FRAME, RESIN SEALING MOLD AND METHOD FOR

MANUFACTURING A SEMICONDUCTOR DEVICE USING THE SAME

Customer Number: 66458

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

RESPONSE UNDER 37 C.F.R. 1.116

Dear Sir:

In response to the final Office Action dated May 15, 2007, please amend the above-referenced application as follows:

Amendments to the Claims begin on page 2.

Remarks begin on page 5.